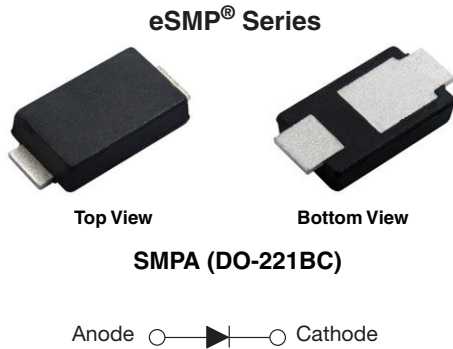


Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier



FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

DESIGN SUPPORT TOOLS

[click logo to get started](#)

3D
Models
Available

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial and automotive applications.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
V_{RRM}	150 V
I_{FSM}	100 A
V_F at $I_F = 8.0$ A ($T_A = 125$ °C)	0.68 V
T_J max.	150 °C
Package	SMPA (DO-221BC)
Circuit configuration	Single

MECHANICAL DATA

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V8PA15	UNIT
Device marking code		V815	
Maximum repetitive peak reverse voltage	V_{RRM}	150	V
Maximum DC forward current	$I_{F(AV)}$ ⁽¹⁾	8.0	A
	$I_{F(AV)}$ ⁽²⁾	2.2	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	100	A
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +150	°C

Notes

(1) Units mounted on 3 cm x 3 cm aluminum PCB

(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4.0 A	T _A = 25 °C	V _F (1)	0.78	-	V
				I _F = 8.0 A	1.1	
	I _F = 4.0 A	T _A = 125 °C		0.59	-	
				I _F = 8.0 A	0.68	
Reverse current	V _R = 100 V	T _A = 25 °C	I _R (2)	0.01	-	mA
		T _A = 125 °C		1.5	-	
	V _R = 150 V	T _A = 25 °C		-	0.5	
		T _A = 125 °C		3	10	
Typical junction capacitance	4.0 V, 1 MHz		C _J	510	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)			
PARAMETER	SYMBOL	V8PA15	UNIT
Typical thermal resistance	R _{θJA} (1)(2)	100	°C/W
	R _{θJM} (3)	5	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{θJA}
- (2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{θJA} - junction to ambient
- (3) Units mounted on 3 cm x 3 cm aluminum PCB; thermal resistance R_{θJM} - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V8PA15-M3/I	0.032	I	14 000	13" diameter plastic tape and reel
V8PA15HM3/I (1)	0.032	I	14 000	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

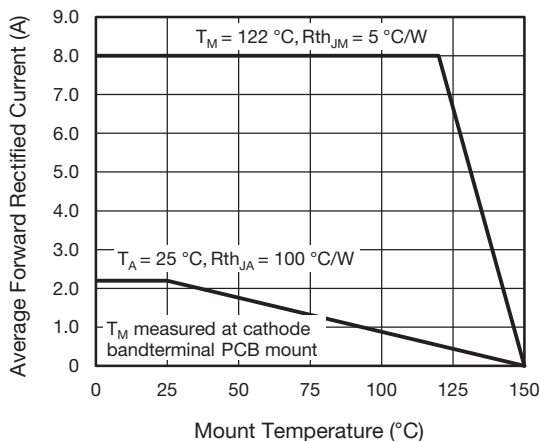


Fig. 1 - Maximum Forward Current Derating Curve

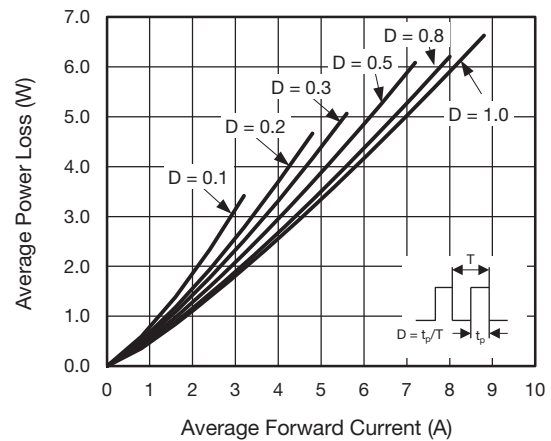


Fig. 2 - Forward Power Loss Characteristics

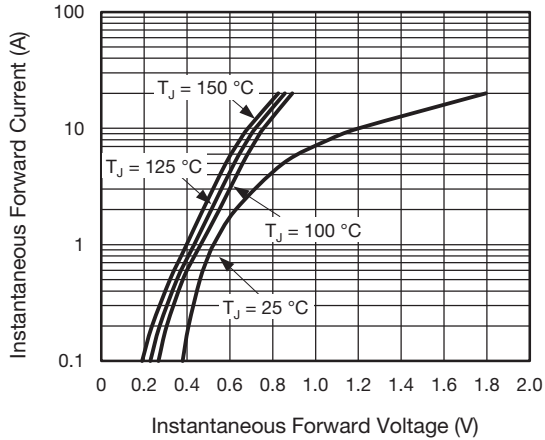


Fig. 3 - Typical Instantaneous Forward Characteristics

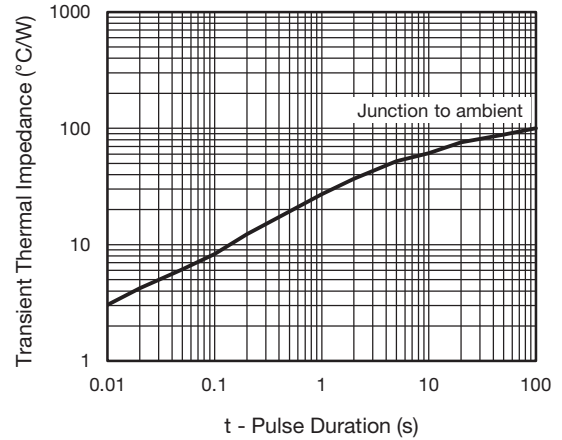


Fig. 6 - Typical Transient Thermal Impedance

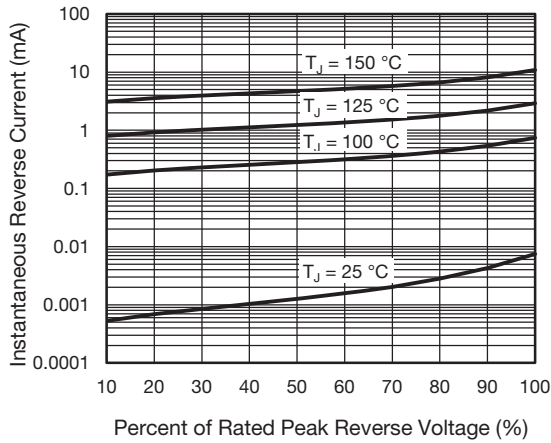


Fig. 4 - Typical Reverse Leakage Characteristics

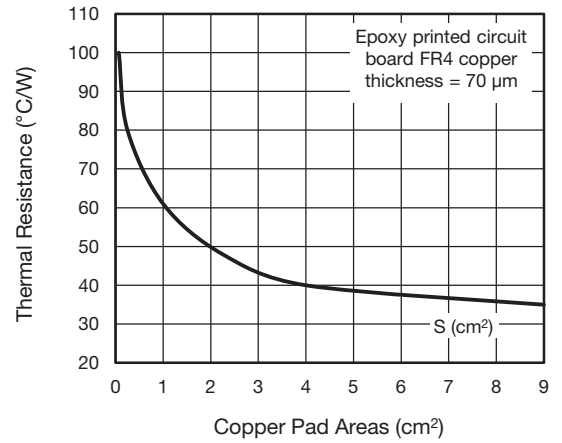


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

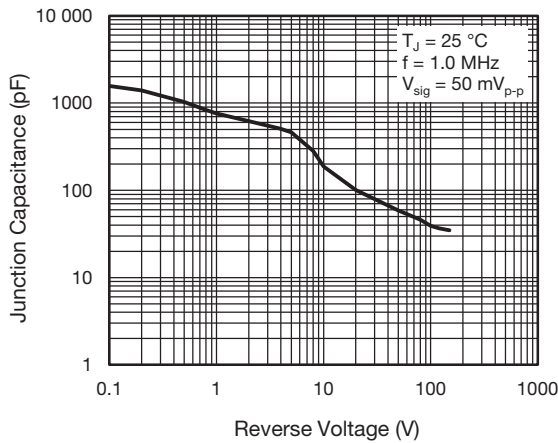
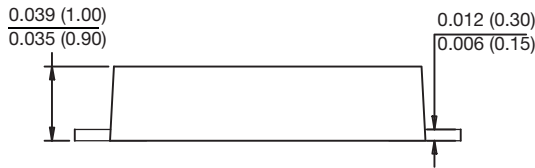
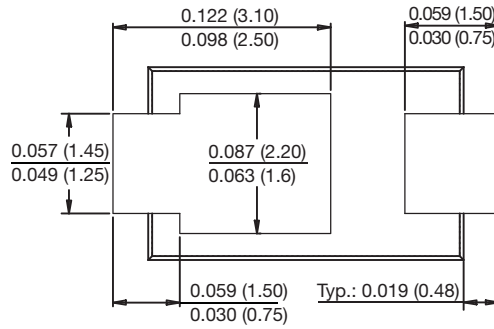
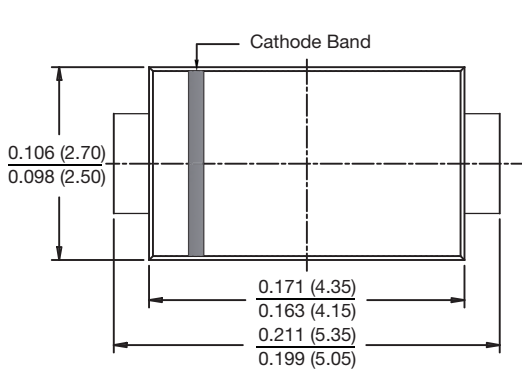


Fig. 5 - Typical Junction Capacitance

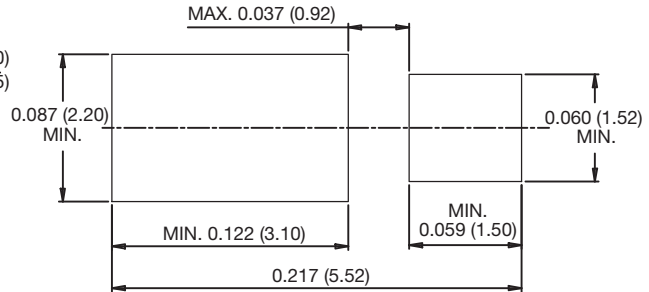


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMPS (DO-221BC)



Mounting Pad Layout





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